

Descriptions

N-Channel Enhancement Mode Field Effect Transistor in a DFN 3*3A-8L Plastic Package.

Features

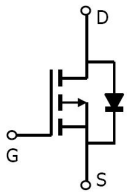
V_{DS} (V) = 30V

I_D = 34 A ($V_{GS} = \pm 20V$)

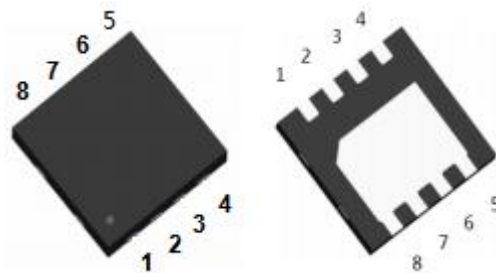
Applications

Suited for low voltage applications such as automotive, DC/DC Converters, and high efficiency switching for power management in portable and battery operated products.

Equivalent Circuit



Pinning



PIN	Description
Pin1	S
Pin2	S
Pin3	S
Pin4	G
Pin5	D
Pin6	D
Pin7	D
Pin8	D

Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	30	V
Drain Current	I _D (Tc=25°C)	34	A
Gate-Source Voltage	V _{GS}	±20	V
Avalanche Current	I _{AS}	12.9	A
Single Pulsed Avalanche Energy	E _{AS}	199	mJ
Power Dissipation	P _D (Tc=25°C)	23	W
Junction Temperature Range	T _J	150	°C
Storage Temperature Range	T _{stg}	-55~150	°C
Maximum Junction-to-Ambient	t ≤ 10s	R _{θJA}	40
	Steady-State	R _{θJA}	75
Maximum Junction-to-Case	Steady-State	R _{θJC}	5.4

Electrical Characteristics(Ta=25°C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V V _{GS} =0V			1.0	μA
		V _{DS} =30V T _J =150°C			50	
Gate-Body Leakage Current Forward	I _{GSS}	V _{GS} =±20V V _{DS} =0V			±0.1	μA
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V I _D =20.0A		11	13	mΩ
		V _{GS} =4.5V I _D =10.0A		16	20	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =250μA	1	1.8	3	V
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V I _F =1.0A		0.7	1.2	V
Signal Source Resistance	R _g	F=1MHz		1.67		Ω
Input Capacitance	C _{iss}	V _{DS} =25V V _{GS} =0V f=1.0MHz		666		pF
Output Capacitance	C _{oss}			26		
Reverse Transfer Capacitance	C _{rss}			63		
Turn-On Delay Time	t _{d(on)}	V _{DS} =15V V _{GS} =10V R _L =0.75Ω R _{GEN} =3.0Ω		4.4		ns
Turn-On Rise Time	t _r			9		
Turn-Off Delay Time	t _{d(off)}			17		
Turn-Off Fall Time	t _f			6		

Electrical Characteristics(Ta=25°C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Total Gate Charge	$Q_{g(10V)}$	$V_{DS}=15V$ $V_{GS}=10V$ $I_D=20.0A$		14		nC
Total Gate Charge	$Q_{g(4.5V)}$			6.6		
Gate-Source Charge	Q_{gs}			2.4		
Gate-Drain Charge	Q_{gd}			3		

Electrical Characteristic Curve

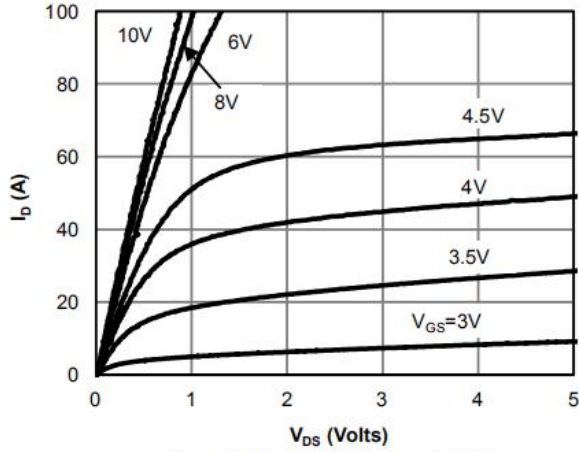


Figure 1: On-Region Characteristics

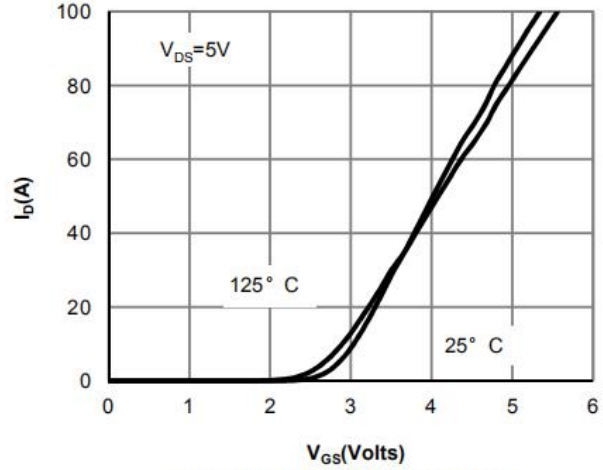


Figure 2: Transfer Characteristics

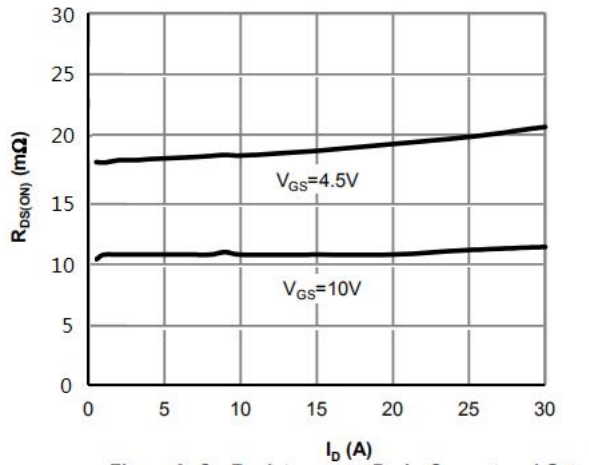


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

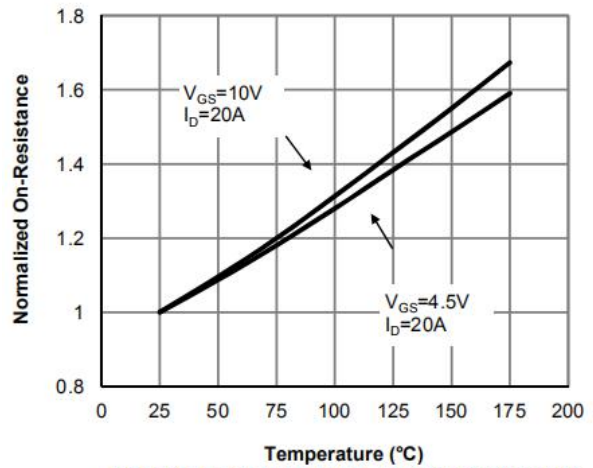


Figure 4: On-Resistance vs. Junction Temperature

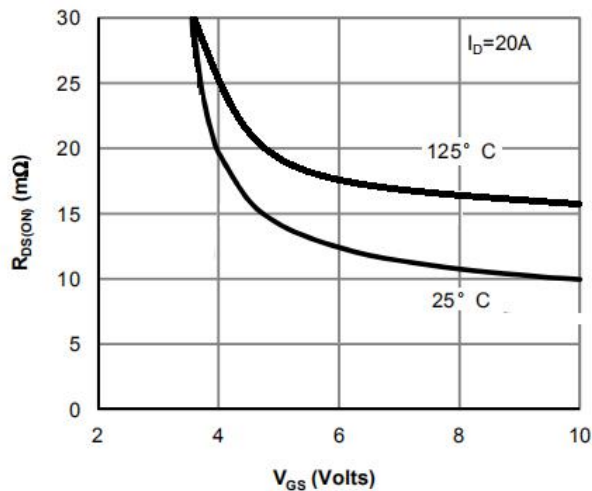


Figure 5: On-Resistance vs. Gate-Source Voltage

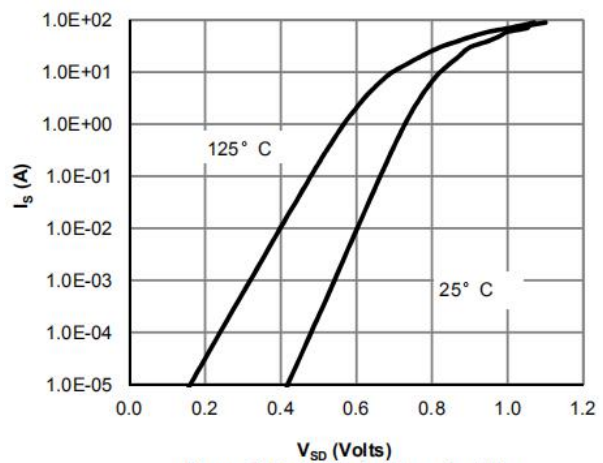


Figure 6: Body-Diode Characteristics

Electrical Characteristic Curve

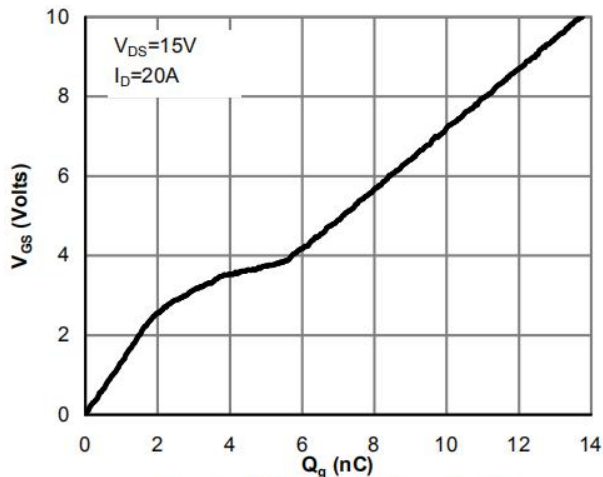


Figure 7: Gate-Charge Characteristics

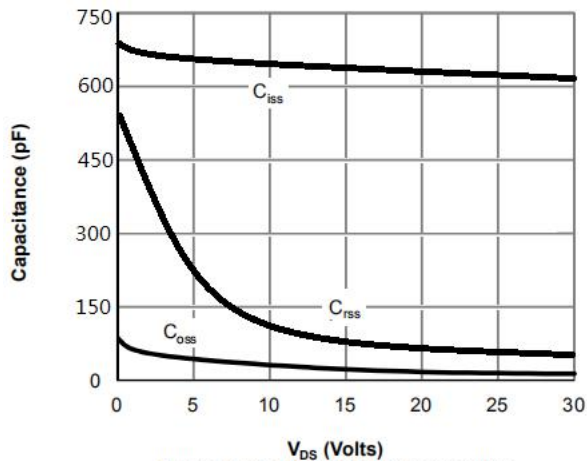


Figure 8: Capacitance Characteristics

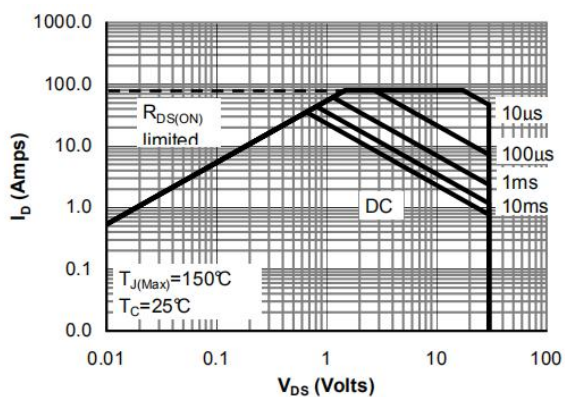


Figure 9: Maximum Forward Biased Safe Operating Area

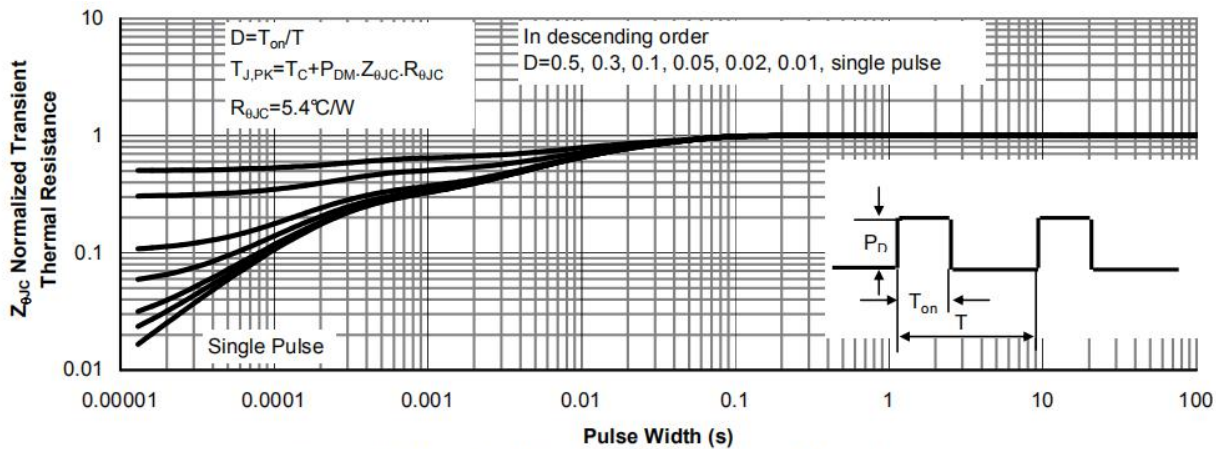


Figure 10: Normalized Maximum Transient Thermal Impedance

Package Dimensions

DFN3X3A-8L

Unit:mm

